

The ARTEMIS Technology Platform and Joint Technological Initiative

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Kostas Glinos

Embedded Systems, IST Programme
DG Information Society and Media
European Commission





Outline

- The ARTEMIS Technology Platform
 - ...and links to the FP7 ICT work programme
- Joint Technology Initiatives in IST
- Information on ARTEMISIA





EmS business expenditure

2003	ICT R&D business expenses/ total R&D business expenses	ES R&D business expenses/ total R&D business expenses	Ratio of business expenditures for R&D in ES/ICT
EU25	17%	9%	56%
US	36%	15%	42%
JP	30%	19%	62%
Rest of Asia	19%	10%	54%
World	27%	13%	49%

2003-2009 in PPP (Purchasing Power Parity)	ICT R&D Business Expenses	ES R&D Business Expenses	ICT R&D Business Expenses	ES R&D Business Expenses
	2003		2009	
EU25	21.7 b€	12.1 b€	34.6 b€	22.9 b€
US	68.0 b€	28.3 b€	103.2 b€	54.9 b€
JP	24.8 b€	15.4 b€	40.7 b€	29.3 b€
Rest of Asia	14.2 b€	7.6 b€	23.1 b€	15.2 b€
World	128.7 b€	63.4 b€	201.6 b€	122.3 b€





Economic importance of EmS

2002-2004 Industry domains	Average annual growth rate for Embedded System market	% of embedded electronics in final value (2004)	% of embedded electronics in final value (2009)
Automotive	10%	20%	36%
Avionics/ Aerospace	14%	n.a.	n.a.
Industrial automation	7%	>13%	22%
Telecommunications	15%	>23%	37%
Consumer electronics and intelligent homes	15%	>14%	41%
Health & medical equipment	18%	25%	33%



Worldwide trends and R&D programmes in Embedded Systems, FAST 2005







Erkii Liikanen Commissioner European Commission



Jürgen Dormann Chairman and CEO

Matt Bross

British Telecom

CTO.



Noel Forgeard Chairman and CEO Airbus





Daniele Pecchini CEO







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Alberto Sangiovanni Vincentelli Feunder and Director Parades





Siegfried Dais Deputy Chairman of the Board, corporate R&D Booch Maii



Pasquale Pistorio President and CEO **ST Microelectronics**



David Levin CEO



Jon Frederik Baksaas CEO



Denis Ranque



Peter Skalicky Vienna University of Technology

Mealthy



Antoine Petit Head of STIC CNRS/Verimag





The Artemis Technology Platform

Advanced research and technology in embedded intelligence and systems

Aim and scope

Graphische Datenverarbeitung

- Develop and drive joint European vision on Embedded Systems
 - R&D and educational challenges
 - structural challenges: IPR, open source, standards, infrastructure,...
- Align fragmented R&D efforts along common strategic agenda at Community, intergovernmental and national levels

ARTEMIS Steering Board includes 10 of the top-25 EU companies in terms of global R&D





ARTEMIS SRA





ARTEMIS SRA links to ICT in FP7 (WP 2007-2008)

- Main locus in ICT WP
- But also in Capacities programme...
 - Research infrastructures
 - Regions of knowledge
 - Research potential (for convergence and outermost regions)
- SF synergies





Embedded Systems Design

40 MEuro







- Theory and methods for Embedded System Design
 - Key issues are heterogeneity, composability, predicta-
 - International cooperation is encouraged
- Suites of interoperable design tools for rapid design and prototyping
 - · Research will contribute to one or more of:
 - 1) Interoperability of tools from SME vendors
 - 2) Consolidating tool developers joint RTD work
 - 3) Open tool frameworks

Expected impact

- Increase the productivity of system development by an order of magnitude
- Stimulate growth of high-tech European Embedded Systems
 Design companies

Reinforce scientific and technological leadership in the engineering

SRA foundational R&D

SRA 3rd priority

SRA

foundational

R&D



Computing systems

Target outcomes

- Novel architectures for multi-core computing systems
 - Architectures and system software for scalable and custor systems incorporating multiple networked, symmetric or hereonfigurable processing elements
 - Key issues are versatility in cost, power, performance, lifecycles; reliability and availability
- Reference architectures for generic embedded platforms
 - Development of a limited number of reference design/architectures
 - Key issues are composability, networking, robustness/sec
 diagnosis/maintainability, resource management, evolvable, 1st priority ation

Expected impact

- Availability of inexpensive generic platforms with high European added value enabling European supplier companies to increase their market share
- Develop European competences in the use of high-end computing to enable the development of new applications

Foster European excellence in computing architectures, system

European Commisoftware and platforms



Target outcomes

- Middleware platforms for embedded systems
 - Key issues: composability, minimum power consumption, open to 3rd parties
 - Emphasis on programmability, reconfiguration, privacy and to
- SRA Cooperating objects and Wireless Sensor Networks 1st priority
 - Spontaneous cooperation of objects in spatial proximity
 - Emphasis on new methods and algorithms, hardware/software platforms for distributed execution and programming and tools for self-organising systems
- Control of large-scale complex distributed systems
 - Models, communication delays, uncertainty, close loop with sensor networks.
 - Key issues: efficiency, robustness, safety, security
 - Targets: manufacturing plants and public infrastructures

Expected impact

- Enable entirely new services and applications
- Make large infrastructures more efficient, flexible and productive
- 100% plant availability, reduce maintenance and accidents



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JTIs - motivation and benefits

- Bringing together fragmented efforts, building critical mass (ERA)
 - Combine, for the first time, national, EC and private funding in a single R&D programme that focuses on joint objectives (SRA)
- Ramping up R&D investment in Europe
 - Provide incentives to industry and Member States to increase R&D investments
- Combining the strengths of trans-national (EUREKA) and European programmes – while overcoming their weaknesses
 - No budget uncertainty (e.g. compared to Eureka)
 - No duplication of evaluation/monitoring procedures (as in Eureka)
 - Shorter time-to-contract
 - No additional red tape for participants



This could pioneer new ways for running industrial R&D programmes in Europe!

☑ Proposed Joint Technology Initiatives in IST

To implement parts of the Strategic Research Agendas of ENIAC and ARTEMIS, aligning fragmented R&D efforts at European level in the fields of:

Nanoelectronics:

- addressing the needs of silicon-based technologies & beyond
- shrinking of CMOS logic & memory devices
- development of valueadded functions for System-on-Chip or Systemin-Package solutions
- equipment & materials
- design automation

Embedded Computing Systems: ubiquitous, interoperable & costeffective embedded systems

- reference designs and architectures
- middleware for interoperabil interoperabil telenor SCOMMERCHRYSLERS CONTROLL Symbian
- integrate der n parade are topis top rototyping



JTI - Principles (1)

Single R&D and Innovation programme

Focusing on SRA

Governance principles

- Transparency & openness in participation & operations
- Industry has the lead
- Three-way separation of powers:
 - Industrial policy
 - Decisions on allocation of public money
 - Operations

Operations

- Accountability
- Unified common processes (established beforehand) for:
 - Annual calls to implement the SRA
 - Proposal evaluation and project selection
 - Project monitoring and reporting





JTI - Principles (2)

- Financing through commitment of resources from all stakeholders
 - Industrial:
 - cash for JTI operational cost and some non-R&D actions
 - in-kind for participation in R&D projects (>50%)
 - Member & Associated States:
 - Yearly <u>earmarked</u> budgets
 - European Commission:
 - Funding to participants in projects in proportion to national payments
 - Other possible sources of funding
 - EIB, structural funds,...



Information Society Technologies

JTI Legal and Governing Structure (draft)

Joint Technology

Initiative

Governing Board
(Industry + Member/Associated States + EC)

Strategic decisions

industrial policy

chair

Research & Innovation Committee

chair

Public Authorities Board budgets, calls content, project selection

Executive Director

Secretariat

daily management and operations



Secretariat

Director

(Option)

Synergetic approach for executing SRA

ETP ARTEMIS

Industry-driven long-term vision Common pan-European SRA

Overall coordination and policy alignment in ERA

Joint project monitoring and programme assessment

FP7

Upstream

IST collab. R&D

ERC, Mare Curie

Research infrastructure

<u>ITL</u>

Downstream

Unified processes

National contracts

EC top-up

EUREKA

Downstream

ITEA2, MEDEA+

National contracts

No EC top-up

<u>National</u> Programmes



JTI vs. FP

Upstream vs. downstream

- Industrial vs. foundational R&D
 - Inquiry-driven, targeted proactive and targeted reactive foundational research
- Industrial vs. academic participation
- Funding rates (50-75% in FP)

Who would participate

- FP: all MAS
- JTI: all MAS but more attractive to organisations from countries committing budget





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